



PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to the Commissioner for Patents, Washington, DC 20231.

September 14, 2001

Date

Rena Iov

#5
Pre/a
10/31/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Whonchee Lee, Scott G. Meikle, Scott E. Moore and
Trung T. Doan

Application No. : 09/888,084

Filed : June 21, 2001

For : METHODS AND APPARATUS FOR ELECTRICAL,
MECHANICAL AND/OR CHEMICAL REMOVAL OF
CONDUCTIVE MATERIAL FROM A MICROELECTRONIC
SUBSTRATE

Docket No. : 108298515US1

Date : September 14, 2001

Commissioner for Patents
Washington, DC 20231

PRELIMINARY AMENDMENT

Dear Commissioner:

In keeping with 37 C.F.R. § 1.121, this paper includes a clean version of the amended specification paragraph. An appendix is attached showing the marked-up version of the specification paragraph amended in the present response. Please amend the application as follows and reconsider the application in light of the following remarks.

A